High Frequency, -55°C to +125°C One-Output Clock Generator



Features

- Frequencies between 119.342001 MHz to 137 MHz accurate to 6 decimal places
- Operating temperature from -55°C to 125°C
- Supply voltage of 1.8V or 2.5V to 3.3V
- Excellent total frequency stability as low as ±20 ppm
- Low power consumption of 4.8 mA typical at 1.8V
- LVCMOS/LVTTL compatible output
- 5-pin SOT23-5 package: 2.9mm x 2.8mm
- RoHS and REACH compliant, Pb-free, Halogen-free and Antimony-free

Applications

Ruggedized equipment in harsh operating environment







Electrical Specifications

Table 1. Electrical Characteristics^[1, 2]

Parameters	Symbol	Min.	Тур.	Max.	Unit	Condition
			Fre	equency Ra	nge	
Output Frequency Range	f	119.342001	-	137	MHz	Refer to Table 14 for the exact list of supported frequencies
	•		Frequenc	cy Stability	and Aging	
Frequency Stability	F_stab	-20	-	+20	ppm	Inclusive of Initial tolerance at 25°C, 1st year aging at 25°C, and
		-25	-	+25	ppm	variations over operating temperature, rated power supply voltage and load (15 pF ± 10%).
		-30	ı	+30	ppm	Voltage and load (10 pt 1 1070).
		-50	-	+50	ppm	
			Operatin	g Temperat	ure Range	
Operating Temperature Range	T_use	-55	-	+125	°C	
		Suj	oply Voltage	and Curre	nt Consum	nption
Supply Voltage	Vdd	1.62	1.8	1.98	V	
		2.25	2.5	2.75	V	
		2.52	2.8	3.08	V	
		2.7	3.0	3.3	V	
		2.97	3.3	3.63	V	
		2.25	-	3.63	V	
Current Consumption	ldd	-	6.2	8	mA	No load condition, f = 125 MHz, Vdd = 2.8V, 3.0V or 3.3V
		-	5.4	7	mA	No load condition, f = 125 MHz, Vdd = 2.5V
		-	4.8	6	mA	No load condition, f = 125 MHz, Vdd = 1.8V
OE Disable Current	I_od	-	-	4.5	mA	Vdd = 2.5V to 3.3V, OE = Low, output in high Z state.
		ı	-	4.0	mA	Vdd = 1.8V, OE = Low, output in high Z state.
Standby Current	I_std	I	2.6	8.5	μА	Vdd = 2.8V to 3.3V, ST = Low, Output is Weakly Pulled Down
		I	1.4	5.5	μΑ	Vdd = 2.5V, ST = Low, Output is Weakly Pulled Down
		-	0.6	3.5	μΑ	Vdd = 1.8V, ST = Low, Output is Weakly Pulled Down
			LVCMOS	Output Cha	racteristic	S
Duty Cycle	DC	45	-	55	%	All Vdds
Rise/Fall Time	Tr, Tf	I	1.0	2.0	ns	Vdd = 2.5V, 2.8V, 3.0V or 3.3V, 20% - 80%
		I	1.3	2.5	ns	Vdd =1.8V, 20% - 80%
		ı	1.0	3	ns	Vdd = 2.25V - 3.63V, 20% - 80%
Output High Voltage	VOH	90%	=	_	Vdd	IOH = -4 mA (Vdd = 3.0V or 3.3V) IOH = -3 mA (Vdd = 2.8V or 2.5V) IOH = -2 mA (Vdd = 1.8V)
Output Low Voltage	VOL	_	-	10%	Vdd	IOL = 4 mA (Vdd = 3.0V or 3.3V) IOL = 3 mA (Vdd = 2.8V or 2.5V) IOL = 2 mA (Vdd = 1.8V)

Rev. 1.0

High Frequency, -55°C to +125°C One-Output Clock Generator



The Smart Timing Choice™

Table 1. Electrical Characteristics^[1, 2] (continued)

Parameters	Symbol	Min.	Тур.	Max.	Unit	Condition
			Inp	ut Characte	ristics	
Input High Voltage	VIH	70%	-	-	Vdd	Pin 1, OE or ST
Input Low Voltage	VIL	_	-	30%	Vdd	Pin 1, OE or ST
Input Pull-up Impedance	Z_in	50	87	150	kΩ	Pin 1, OE logic high or logic low, or ST logic high
		2	ı	-	MΩ	Pin 1, ST logic low
			Startup	and Resur	ne Timing	
Startup Time	T_start	_	-	5	ms	Measured from the time Vdd reaches 90% of final value
Enable/Disable Time	T_oe	-	-	130	ns	f = 119.342001 MHz. For other frequencies, T_oe = 100 ns + 3 * clock periods
Resume Time	T_resume	-	-	5	ms	Measured from the time ST pin crosses 50% threshold
				Jitter		
RMS Period Jitter	T_jitt	-	1.6	2.5	ps	f = 125 MHz, Vdd = 2.5V, 2.8V, 3.0V or 3.3V
		-	1.8	3	ps	f = 125 MHz, Vdd = 1.8V
Peak-to-peak Period Jitter	T_pk	_	12	20	ps	f = 125 MHz, Vdd = 2.5V, 2.8V, 3.0V or 3.3V
		-	14	25	ps	f = 125 MHz, Vdd = 1.8V
RMS Phase Jitter (random)	T_phj	_	0.5	0.8	ps	f = 125 MHz, Integration bandwidth = 900 kHz to 7.5 MHz
		_	1.3	2	ps	f = 125 MHz, Integration bandwidth = 12 kHz to 20 MHz

Notes:

- 1. All electrical specifications in the above table are specified with 15 pF output load and for all Vdd(s) unless otherwise stated.
- 2. The typical value of any parameter in the Electrical Characteristics table is specified for the nominal value of the highest voltage option for that parameter and at 25 °C temperature.

Table 2. Pin Description

Pin	Symbol		Functionality
1	GND	Power	Electrical ground ^[3]
2	NC	No Connect	No connect
		Output Enable	H ^[4] : specified frequency output L: output is high impedance. Only output driver is disabled.
3	OE/ ST/NC Stan		H or Open ^[4] : specified frequency output L: output is low (weak pull down). Device goes to sleep mode. Supply current reduces to I_std.
No Connect		No Connect	Any voltage between 0 and Vdd or Open ^[4] : Specified frequency output. Pin 3 has no function.
4	VDD	Power	Power supply voltage ^[3]
5	OUT	Output	Oscillator output

Notes:

- 3. A capacitor of value 0.1 μF or higher between Vdd and GND is required.
- In OE or ST mode, a pull-up resistor of 10 kΩ or less is recommended if pin 3 is not externally driven.
 If pin 3 needs to be left floating, use the NC option.

Top View

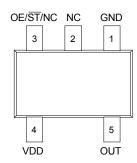


Figure 1. Pin Assignments

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Table 3. Absolute Maximum Limits

Attempted operation outside the absolute maximum ratings may cause permanent damage to the part. Actual performance of the IC is only guaranteed within the operational specifications, not at absolute maximum ratings.

Parameter	Min.	Max.	Unit
Storage Temperature	-65	150	°C
Vdd	-0.5	4	V
Electrostatic Discharge	-	2000	V
Soldering Temperature (follow standard Pb free soldering guidelines)	-	260	°C
Junction Temperature ^[5]	-	150	°C

Note:

Table 4. Thermal Consideration^[6]

Package	θ _{JA} , 4 Layer Board (°C/W)	θ _{JC} , Bottom (°C/W)
SOT23-5	421	175

Note:

6. Refer to JESD51 for θ_{JA} and θ_{JC} definitions, and reference layout used to determine the θ_{JA} and θ_{JC} values in the above table.

Table 5. Maximum Operating Junction Temperature^[7]

Max Operating Temperature (ambient)	Maximum Operating Junction Temperature		
125°C	135°C		

Note:

7. Datasheet specifications are not guaranteed if junction temperature exceeds the maximum operating junction temperature.

Table 6. Environmental Compliance

Parameter	Condition/Test Method
Mechanical Shock	MIL-STD-883F, Method 2002
Mechanical Vibration	MIL-STD-883F, Method 2007
Temperature Cycle	JESD22, Method A104
Solderability	MIL-STD-883F, Method 2003
Moisture Sensitivity Level	MSL1 @ 260°C

^{5.} Exceeding this temperature for extended period of time may damage the device.



Test Circuit and Waveform^[8]

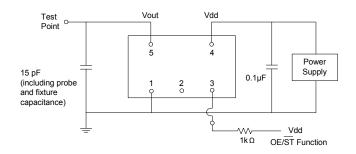


Figure 2. Test Circuit

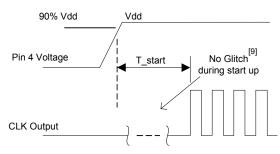
Note:

8. Duty Cycle is computed as Duty Cycle = TH/Period.

Tr — Tf 80% Vdd 50% 20% Vdd High Pulse (TH) Period Period

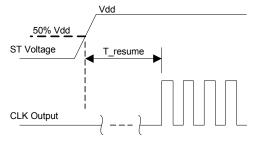
Figure 3. Output Waveform

Timing Diagrams



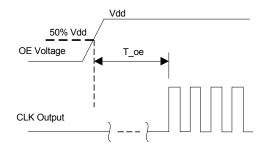
T_start: Time to start from power-off

Figure 4. Startup Timing (OE/ST Mode)



T_resume: Time to resume from ST

Figure 5. Standby Resume Timing (ST Mode Only)

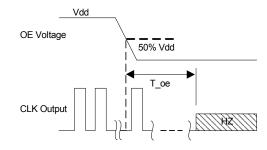


T_oe: Time to re-enable the clock output

Figure 6. OE Enable Timing (OE Mode Only)

Note:

9. SiT2021 has "no runt" pulses and "no glitch" output during startup or resume.



 T_oe : Time to put the output in High Z mode

Figure 7. OE Disable Timing (OE Mode Only)

3.5

3.0

2.0

1.0

RMS period jitter (ps)



Performance Plots^[10]

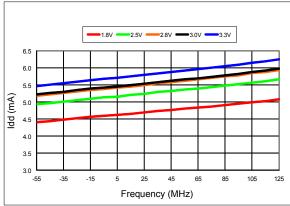


Figure 8. Idd vs Frequency

■2.8 V ■■3.0 V ■

133



Figure 10. RMS Period Jitter vs Frequency

Frequency (MHz)

123

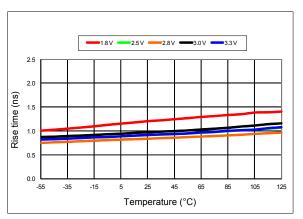


Figure 12. 20%-80% Rise Time vs Temperature

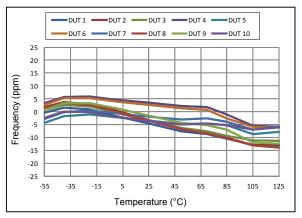


Figure 9. Frequency vs Temperature

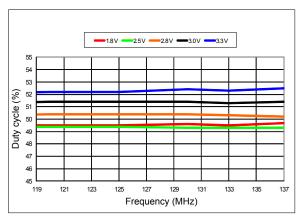


Figure 11. Duty Cycle vs Frequency

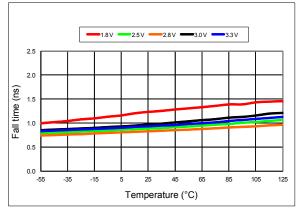


Figure 13. 20%-80% Fall Time vs Temperature

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Performance Plots^[10]

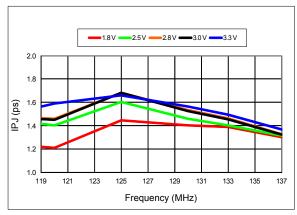


Figure 14. RMS Integrated Phase Jitter Random (12 kHz to 20 MHz) vs Frequency^[11]

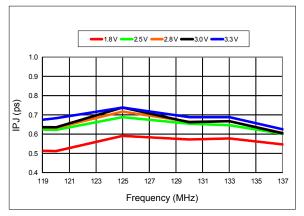


Figure 15. RMS Integrated Phase Jitter Random (900 kHz to 7.5 MHz) vs Frequency^[11]

Notes:

- 10. All plots are measured with 15 pF load at room temperature, unless otherwise stated.
- 11. Phase noise plots are measured with Agilent E5052B signal source analyzer.

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Programmable Drive Strength

The SiT2021 includes a programmable drive strength feature to provide a simple, flexible tool to optimize the clock rise/fall time for specific applications. Benefits from the programmable drive strength feature are:

- Improves system radiated electromagnetic interference (EMI) by slowing down the clock rise/fall time.
- Improves the downstream clock receiver's (RX) jitter by decreasing (speeding up) the clock rise/fall time.
- Ability to drive large capacitive loads while maintaining full swing with sharp edge rates.

For more detailed information about rise/fall time control and drive strength selection, see the SiTime Application Notes section: http://www.sitime.com/support/application-notes.

EMI Reduction by Slowing Rise/Fall Time

Figure 16 shows the harmonic power reduction as the rise/fall times are increased (slowed down). The rise/fall times are expressed as a ratio of the clock period. For the ratio of 0.05, the signal is very close to a square wave. For the ratio of 0.45, the rise/fall times are very close to near-triangular waveform. These results, for example, show that the 11th clock harmonic can be reduced by 35 dB if the rise/fall edge is increased from 5% of the period to 45% of the period.

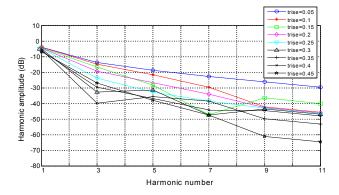


Figure 16. Harmonic EMI reduction as a Function of Slower Rise/Fall Time

Jitter Reduction with Faster Rise/Fall Time

Power supply noise can be a source of jitter for the downstream chipset. One way to reduce this jitter is to speed up the rise/fall time of the input clock. Some chipsets may also require faster rise/fall time in order to reduce their sensitivity to this type of jitter. Refer to the Rise/Fall Time Tables (Table 7 to Table 11) to determine the proper drive strength.

High Output Load Capability

The rise/fall time of the input clock varies as a function of the actual capacitive load the clock drives. At any given drive strength, the rise/fall time becomes slower as the output load increases. As an example, for a 3.3V SiT2021 device with default drive strength setting, the typical rise/fall time is 0.46 ns for 5 pF output load. The typical rise/fall time slows down to 1 ns when the output load increases to 15 pF. One can choose to speed up the rise/fall time to 0.72 ns by then increasing the driven strength setting on the SiT2021 to "F".

The SiT2021 can support up to 30 pF in maximum capacitive loads with up to 3 additional drive strength settings. Refer to the Rise/Tall Time Tables (Table 7 to 11) to determine the proper drive strength for the desired combination of output load vs. rise/fall time.

SiT2021 Drive Strength Selection

Tables 7 through 11 define the rise/fall time for a given capacitive load and supply voltage.

- 1. Select the table that matches the SiT2021 nominal supply voltage (1.8V, 2.5V, 2.8V, 3.0V, 3.3V).
- 2. Select the capacitive load column that matches the application requirement (5 pF to 30 pF).
- 3. Under the capacitive load column, select the desired rise/fall times.
- 4. The left-most column represents the part number code for the corresponding drive strength.
- 5. Add the drive strength code to the part number for ordering purposes.

Calculating Maximum Frequency

Based on the rise and fall time data given in Tables 7 through 11, the maximum frequency the oscillator can operate with guaranteed full swing of the output voltage over temperature can be calculated as follows:

Max Frequency =
$$\frac{1}{5 \times Trf \ 20/80}$$

where Trf_20/80 is the typical value for 20%-80% rise/fall time.

Example 1

Calculate f_{MAX} for the following condition:

- Vdd = 3.3V (Table 11)
- · Capacitive Load: 30 pF
- Desired Tr/f time = 1.46 ns (rise/fall time part number code = U)

Part number for the above example:

SiT2021AIU12-33E-136.986300



Drive strength code is inserted here. Default setting is "-"

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Rise/Fall Time (20% to 80%) vs C_{LOAD} Tables

Table 7. Vdd = 1.8V Rise/Fall Times for Specific C_{LOAD}

Rise/Fall Time Typ (ns)					
Drive Strength \ C _{LOAD} 5 pF 15 pF 30 pF					
T	0.93	n/a	n/a		
E	0.78	n/a	n/a		
U	0.70	1.48	n/a		
F or "-": default	0.65	1.30	n/a		

Table 8. Vdd = 2.5V Rise/Fall Times for Specific C_{LOAD}

Rise/Fall Time Typ (ns)					
Drive Strength \ C LOAD	5 pF	15 pF	30 pF		
R	1.45	n/a	n/a		
В	1.09	n/a	n/a		
Т	0.62	1.28	n/a		
E	0.54	1.00	n/a		
U or "-": default	0.43	0.96	n/a		
F	0.34	0.88	n/a		

Table 9. Vdd = 2.8V Rise/Fall Times for Specific C_{LOAD}

Rise/Fall Time Typ (ns)				
Drive Strength \ C _{LOAD}	5 pF	15 pF	30 pF	
R	1.29	n/a	n/a	
В	0.97	n/a	n/a	
Т	0.55	1.12	n/a	
E	0.44	1.00	n/a	
U or "-": default	0.34	0.88	n/a	
F	0.29	0.81	1.48	

Table 10. Vdd = 3.0V Rise/Fall Times for Specific C_{LOAD}

Rise/Fall Time Typ (ns)					
Drive Strength \ C _{LOAD}	5 pF	15 pF	30 pF		
R	1.22	n/a	n/a		
В	0.89	n/a	n/a		
T or "-": default	0.51	1.00	n/a		
ш	0.38	0.92	n/a		
U	0.30	0.83	n/a		
F	0.27	0.76	1.39		

Table 11. Vdd = 3.3V Rise/Fall Times for Specific C_{LOAD}

Rise/Fall Time Typ (ns)					
Drive Strength \ C _{LOAD}	5 pF	15 pF	30 pF		
R	1.16	n/a	n/a		
В	0.81	n/a	n/a		
T or "-": default	0.46	1.00	n/a		
E	0.33	0.87	n/a		
U	0.28	0.79	1.46		
F	0.25	0.72	1.31		

Note:

^{12. &}quot;n/a" in Table 7 to Table 11 indicates that the resulting rise/fall time from the respective combination of the drive strength and output load does not provide rail-to-rail swing and is not available.

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Pin 3 Configuration Options (OE, ST, or NC)

Pin 3 of the SiT2021 can be factory-programmed to support three modes: Output Enable (OE), standby $\overline{(ST)}$ or No Connect (NC).

Output Enable (OE) Mode

In the OE mode, applying logic Low to the OE pin only disables the output driver and puts it in Hi-Z mode. The core of the device continues to operate normally. Power consumption is reduced due to the inactivity of the output. When the OE pin is pulled High, the output is typically enabled in <1 μ s.

Standby (ST) Mode

In the \overline{ST} mode, a device enters into the standby mode when Pin 3 pulled Low. All internal circuits of the device are turned off. The current is reduced to a standby current, typically in the range of a few μA . When \overline{ST} is pulled High, the device goes through the "resume" process, which can take up to 5 ms.

No Connect (NC) Mode

In the NC mode, the device always operates in its normal mode and outputs the specified frequency regardless of the logic level on pin 3.

Table 12 below summarizes the key relevant parameters in the operation of the device in OE, \overline{ST} , or NC mode.

Table 12. OE vs. ST vs. NC

	OE	ST	NC
Active current 125 MHz (max, 1.8V)	6 mA	6 mA	6 mA
OE disable current (max. 1.8V)	4 mA	N/A	N/A
Standby current (typical 1.8V)	N/A	0.6 uA	N/A
OE enable time at 125 MHz (max)	130 ns	N/A	N/A
Resume time from standby (max, all frequency)	N/A	5 ms	N/A
Output driver in OE disable/standby mode	High Z	weak pull-down	N/A

Output on Startup and Resume

The SiT2021 comes with gated output. Its clock output is accurate to the rated frequency stability within the first pulse from initial device startup or resume from the standby mode. In addition, the SiT2021 has "no runt" pulses, "no glitch" output during startup or resume as shown in the waveform captures in Figure 17 and Figure 18.

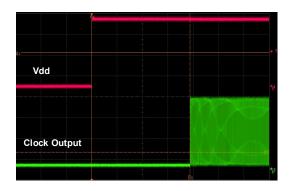


Figure 17. Startup Waveform vs. Vdd

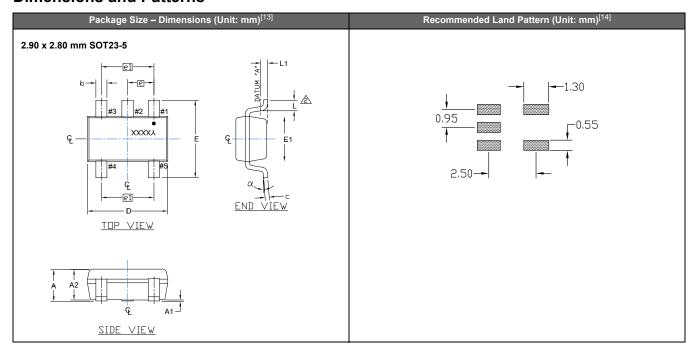


Figure 18. Startup Waveform vs. Vdd (Zoomed-in View of Figure 17)

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Dimensions and Patterns



Notes:

13.Top marking: Y denotes manufacturing origin and XXXX denotes manufacturing lot number. The value of "Y" will depend on the assembly location of the device.

14. A capacitor value of 0.1 µF between Vdd and GND is required

Table 13. Dimension Table

Symbol	Min.	Nom.	Max.	
Α	0.90	1.27 1.4		
A1	0.00 0.07		0.15	
A2	0.90	0.90 1.2		
b	0.30	0.35	0.50	
С	0.14	0.153	0.20	
D	2.90			
E	2.80			
E1	1.60			
е	0.95			
e1	1.90			
L	0.30	0.38	0.55	
L1		0.25		
а	0°	_	8°	

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Ordering Information

The Part No. Guide is for reference only. To customize and build an exact part number, use the SiTime <u>Part Number</u> <u>Generator.</u>

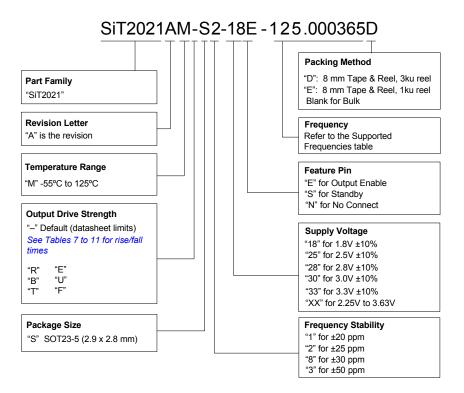


Table 14. List of Supported Frequencies^[15, 16]

Frequency Range -55 to +125°C			
Min.	Max.		
119.342001 MHz	120.238999 MHz		
120.262001 MHz	121.169999 MHz		
121.243001 MHz	121.600999 MHz		
123.948001 MHz	137.000000 MHz		

Notes:

- 15. Any frequency within the min and max values in the above table are supported with 6 decimal places of accuracy.
- 16. Please contact SiTime for frequencies that are not listed in the tables above.

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Table 15. Additional Information

Document	Description	Download Link
Time Machine II	MEMS oscillator programmer	http://www.sitime.com/support/time-machine-oscillator-programmer
Field Programmable Oscillators	Devices that can be programmable in the field by Time Machine II	http://www.sitime.com/products/field-programmable-oscillators
Manufacturing Notes	Tape & Reel dimension, reflow profile and other manufacturing related info	http://www.sitime.com/component/docman/doc_download/85-manufacturing-notes-for-sitime-oscillators
Qualification Reports	RoHS report, reliability reports, composition reports	http://www.sitime.com/support/quality-and-reliability
Performance Reports	Additional performance data such as phase noise, current consumption and jitter for selected frequencies	http://www.sitime.com/support/performance-measurement-report
Termination Techniques	Termination design recommendations	http://www.sitime.com/support/application-notes
Layout Techniques	Layout recommendations	http://www.sitime.com/support/application-notes

Revision History

Table 16. Datasheet Version and Change Log

Version	Release Date	Change Summary
0.95	1/28/14	Initial preliminary release
1.0	10/16/14	Added height dimension in the package drawing Minor correction of the top mark drawing in Figure 1

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Supplemental Information

The Supplemental Information section is not part of the datasheet and is for informational purposes only.



Silicon MEMS Outperforms Quartz

Silicon MEMS Outperforms Quartz



Best Reliability

Silicon is inherently more reliable than quartz. Unlike quartz suppliers, SiTime has in-house MEMS and analog CMOS expertise, which allows SiTime to develop the most reliable products. Figure 1 shows a comparison with quartz technology.

Why is SiTime Best in Class:

- SiTime's MEMS resonators are vacuum sealed using an advanced EpiSeal[™] process, which eliminates foreign particles and improves long term aging and reliability
- · World-class MEMS and CMOS design expertise

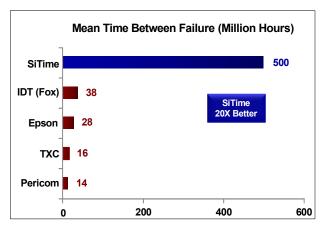


Figure 1. Reliability Comparison^[1]

Best Aging

Unlike quartz, MEMS oscillators have excellent long term aging performance which is why every new SiTime product specifies 10-year aging. A comparison is shown in Figure 2.

Why is SiTime Best in Class:

- SiTime's MEMS resonators are vacuum sealed using an advanced EpiSeal process, which eliminates foreign particles and improves long term aging and reliability
- Inherently better immunity of electrostatically driven MEMS resonator

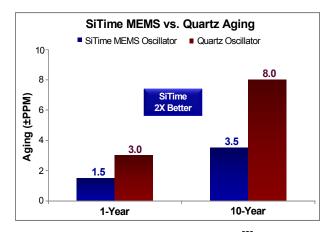


Figure 2. Aging Comparison^[2]

Best Electro Magnetic Susceptibility (EMS)

SiTime's oscillators in plastic packages are up to 54 times more immune to external electromagnetic fields than quartz oscillators as shown in Figure 3.

Why is SiTime Best in Class:

- Internal differential architecture for best common mode noise rejection
- Electrostatically driven MEMS resonator is more immune to EMS

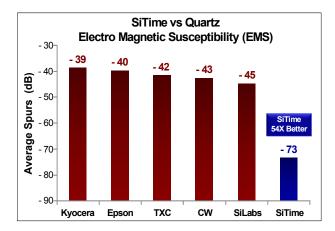


Figure 3. Electro Magnetic Susceptibility (EMS)[3]

Best Power Supply Noise Rejection

SiTime's MEMS oscillators are more resilient against noise on the power supply. A comparison is shown in Figure 4.

Why is SiTime Best in Class:

- On-chip regulators and internal differential architecture for common mode noise rejection
- · Best analog CMOS design expertise

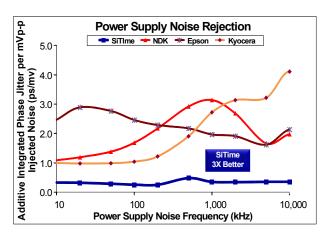


Figure 4. Power Supply Noise Rejection^[4]

Silicon MEMS Outperforms Quartz



Best Vibration Robustness

High-vibration environments are all around us. All electronics, from handheld devices to enterprise servers and storage systems are subject to vibration. Figure 5 shows a comparison of vibration robustness.

Why is SiTime Best in Class:

- The moving mass of SiTime's MEMS resonators is up to 3000 times smaller than guartz
- Center-anchored MEMS resonator is the most robust design

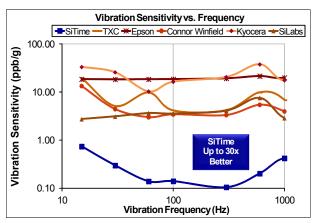


Figure 5. Vibration Robustness^[5]

Notes:

- 1. Data Source: Reliability documents of named companies.
- 2. Data source: SiTime and quartz oscillator devices datasheets.
- 3. Test conditions for Electro Magnetic Susceptibility (EMS):
 - According to IEC EN61000-4.3 (Electromagnetic compatibility standard)
 - Field strength: 3V/m
 - Radiated signal modulation: AM 1 kHz at 80% depth
 - Carrier frequency scan: 80 MHz 1 GHz in 1% steps
 - · Antenna polarization: Vertical
 - DUT position: Center aligned to antenna

Devices used in this test:

SiTime, SiT9120AC-1D2-33E156.250000 - MEMS based - 156.25 MHz

Epson, EG-2102CA 156.2500M-PHPAL3 - SAW based - 156.25 MHz

TXC, BB-156.250MBE-T - 3rd Overtone quartz based - 156.25 MHz

Kyocera, KC7050T156.250P30E00 - SAW based - 156.25 MHz

Connor Winfield (CW), P123-156.25M - 3rd overtone quartz based - 156.25 MHz

SiLabs, Si590AB-BDG - 3rd overtone quartz based - 156.25 MHz

4. 50 mV pk-pk Sinusoidal voltage.

Devices used in this test:

SiTime, SiT8208AI-33-33E-25.000000, MEMS based - 25 MHz

NDK, NZ2523SB-25.6M - quartz based - 25.6 MHz

Kyocera, KC2016B25M0C1GE00 - quartz based - 25 MHz

Epson, SG-310SCF-25M0-MB3 - quartz based - 25 MHz

- 5. Devices used in this test: same as EMS test stated in Note 3.
- 6. Test conditions for shock test:
 - MIL-STD-883F Method 2002
 - Condition A: half sine wave shock pulse, 500-g, 1ms
 - \bullet Continuous frequency measurement in 100 μs gate time for 10 seconds

Devices used in this test: same as EMS test stated in Note 3

7. Additional data, including setup and detailed results, is available upon request to qualified customers. Please contact productsupport@sitime.com.

Best Shock Robustness

SiTime's oscillators can withstand at least $50,000\ g$ shock. They all maintain their electrical performance in operation during shock events. A comparison with quartz devices is shown in Figure 6.

Why is SiTime Best in Class:

- The moving mass of SiTime's MEMS resonators is up to 3000 times smaller than guartz
- Center-anchored MEMS resonator is the most robust design

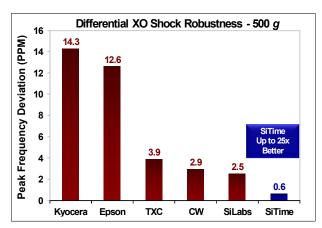


Figure 6. Shock Robustness^[6]

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